	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
1	BRS	L1	1165	(card or cartridge) same cooling and connector	USPAT	2004/08/19 12:27			0
2	BRS	L2	306	1 and @py<1993	USPAT	2004/08/19 12:27			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
1	IS&R	L15	6	(("6608753") or ("6771509") or ("6515864") or ("6404639") or ("6025993") or ("5659459")).PN.	USPAT	2004/08/19 10:43			0
2	IS&R	L16	62	(("2164803") or ("0198378") or ("3416348") or ("3237878") or ("6515864") or ("6515823") or ("6404639") or ("6025993") or ("5659459") or ("5615085") or ("5548487") or ("5526229") or ("5504669") or ("5481656") or ("5475563") or ("5473506") or ("5437041") or ("5432913") or ("5424913") or ("5389819") or ("5289342") or ("5287247") or ("5262922") or ("5227631") or ("5208732") or ("5198965") or ("5195176") or ("5184211") or ("5162610") or ("5142614") or ("5138521") or ("5136464") or	USPAT	2004/08/19 10:43			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
3	IS&R	L17	44	(("6515864") or ("6404639") or ("6025993") or ("5659459") or ("5615085") or ("5548487") or ("5526229") or ("5504669") or ("5481656") or ("5475563") or ("5473506") or ("5437041") or ("5432913") or ("5424913") or ("5289342") or ("5287247") or ("5227631") or ("5208732") or ("5198965") or ("5195176") or ("5162610") or ("5142614") or ("5136464") or ("5136146") or ("5060112") or ("5031076") or ("5024264") or ("5016086") or ("4962444") or ("4914551") or ("4872091") or ("4849944") or	USPA T	2004/08/1 9 10:44			0
4	IS&R	L18	3	(("5615085") or ("5526229") or ("5437041").PN.	USPA T	2004/08/1 9 10:49			0
5	IS&R	L19	1	("3225262").PN.	USPA T	2004/08/1 9 10:50			0
6	IS&R	L20	1	("4855869").PN.	USPA T	2004/08/1 9 10:50			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
7	BRS	L21	3585	((circuit adj board) or substrate) same (cooling same (compress$3 or resilient or foam or rubber or silicon))	USPAT	2004/08/19 10:59			0
8	BRS	L22	89	21 and (CPU or processor or microprocessor or ic) same (heat adj sink)	USPAT	2004/08/19 11:00			0
9	BRS	L23	1293	((circuit adj board) or substrate) same (cooling same (compress$3 or resilient or foam or rubber or silicon))	EPO; JPO; DERWENT; IBM_TDB	2004/08/19 10:57			0
10	BRS	L24	9	23 and (CPU or processor or microprocessor or ic) same (heat adj sink)	EPO; JPO; DERWENT; IBM_TDB	2004/08/19 10:57			0
11	BRS	L25	20003	((circuit adj board) or substrate) same (support$3 same (compress$3 or resilient or foam or rubber or silicon))	USPAT	2004/08/19 11:03			0
12	BRS	L26	112	25 and (CPU or processor or microprocessor or ic) same (heat adj sink)	USPAT	2004/08/19 11:03			0
13	BRS	L27	83	26 not 22	USPAT	2004/08/19 11:00			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
14	BRS	L28	13704	((circuit adj board) or substrate) same (support$3 same (compress$3 or resilient or foam or rubber or silicon))	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 11:05			0
15	BRS	L29	4	28 and (CPU or processor or microprocessor or ic) same (heat adj sink)	EPO; JPO; DERWENT; IBM_TDB	2004/08/19 11:06			0
16	BRS	L30	10877	((circuit adj board) or substrate) same (bottom same (compress$3 or resilient or foam or rubber or silicon))	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/19 11:06			0
17	BRS	L31	3	30 and (CPU or processor or microprocessor or ic) same (heat adj sink)	EPO; JPO; DERWENT; IBM_TDB	2004/08/19 11:05			0
18	BRS	L32	16598	((circuit adj board) or substrate) same (bottom same (compress$3 or resilient or foam or rubber or silicon))	USPAT	2004/08/19 11:06			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
19	BRS	L33	117	32 and (CPU or processor or microprocessor or ic) same (heat adj sink)	USPAT	2004/08/19 11:06			0

#	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
1	IS&R	L1	6	(("6771509") or ("6608753") or ("6515864") or ("6404639") or ("6025993") or ("5659459")).PN.	USPAT	2004/08/18 13:51			0
2	BRS	L2	10372	((circuit adj board) or substrate) and heat and cooling and spring$1	USPAT	2004/08/18 13:52			0
3	BRS	L3	8678	((circuit adj board) or substrate) same (heat adj sink) samespring$1	USPAT	2004/08/18 13:53			0
4	BRS	L4	529	((circuit adj board) or substrate) same (heat adj sink) same spring$1	USPAT	2004/08/18 14:28			0
5	BRS	L5	214541	4 and 5-20-92 to present	USPAT	2004/08/18 13:58			0
6	BRS	L6	529	4 (5-20-92 to present).py.	USPAT	2004/08/18 14:06			0
7	BRS	L7	0	4 and @pd=19920520	USPAT	2004/08/18 14:08			0
8	BRS	L8	128	4 and @py<1992	USPAT	2004/08/18 14:08			0
9	BRS	L9	138	4 and @py<1993	USPAT	2004/08/18 14:28			0
10	BRS	L11	0	10 and @py<1993	USPAT	2004/08/18 14:17			0
11	BRS	L10	289	((circuit adj board) or substrate) same (heat adj sink) same spring$1	EPO; JPO; DERWENT; IBM_TDB	2004/08/18 14:23			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
12	BRS	L12	612	((circuit adj board) or substrate) same (heat adj sink) same (pressed or compressed or resilient)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 14:24			0
13	BRS	L13	452	12 not 6	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 14:24			0
14	BRS	L14	71	13 and @py<1993	USPAT	2004/08/18 14:24			0
15	BRS	L15	1152	((circuit adj board) or substrate) and (heat adj sink) same spring$1	USPAT	2004/08/18 14:51			0
16	BRS	L16	623	15 not 4	USPAT	2004/08/18 14:28			0
17	BRS	L17	180	16 and @py<1993	USPAT	2004/08/18 14:38			0
18	BRS	L18	362	((circuit adj board) or substrate) and (heat adj sink) same spring$1	EPO; JPO; DERWENT; IBM_TDB	2004/08/18 14:38			0
19	BRS	L19	0	18 and @py<1993	USPAT	2004/08/18 14:38			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
20	BRS	L20	136	18 and @py<1993	EPO; JPO; DERWENT; IBM_TDB	2004/08/18 14:46			0
21	BRS	L21	175	((circuit adj board) or substrate) same processor same spring$1 same spring$1	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 14:46			0
22	BRS	L22	175	((circuit adj board) or substrate) same processor same spring$1	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 14:49			0
23	BRS	L23	36	22 and @py<1993	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 14:50			0
24	BRS	L24	51	((circuit adj board) or substrate) same processor same (resilient or compressible)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 14:49			0

Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
25	BRS	L25	9	24 and @py<1993	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 14:51			0
26	BRS	L26	3883	((circuit adj board) or substrate) and (heat adj sink) and spring$1	USPAT	2004/08/18 15:24			0
27	BRS	L27	1076	26 and @py<1993	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 15:16			0
28	BRS	L28	896	27 not 17	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 14:52			0
29	BRS	L29	896	28 not 20	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 14:53			0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
30	BRS	L30	427	((circuit adj board) or substrate) and (heat adj sink) and spring$1	EPO; JPO; DERWENT; IBM_TDB	2004/08/18 15:16			0
31	BRS	L31	167	30 and @py<1993	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 15:22			0
32	BRS	L32	622	361/704.ccls. and spring$1	USPAT	2004/08/18 15:22			0
33	BRS	L33	56	32 and @py<1993	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 15:25			0
34	BRS	L34	13437	((circuit adj board) or substrate) and cooling and spring$1	USPAT	2004/08/18 15:24			0
35	BRS	L35	11432	34 not 26	USPAT	2004/08/18 15:24			0
36	BRS	L36	3137	35 and @py<1993	USPAT	2004/08/18 15:25			0
37	BRS	L37	259	36 and processor	USPAT	2004/08/18 15:26			0

#	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
1	IS&R	L1	6	(("6771509") or ("6608753") or ("6515864") or ("6404639") or ("6025993") or ("5659459")).PN.	USPA	2004/08/18 13:51			0
2	BRS	L2	10372	((circuit adj board) or substrate) and heat and cooling and spring$1	USPA	2004/08/18 13:52			0
3	BRS	L3	8678	((circuit adj board) or substrate) same (heat adj sink) samespring$1	USPA	2004/08/18 13:53			0
4	BRS	L4	529	((circuit adj board) or substrate) same (heat adj sink) same spring$1	USPA	2004/08/18 15:44			0
5	BRS	L5	1	214544 and 5-20-92 to present	USPA	2004/08/18 13:58			0
6	BRS	L6	529	4 (5-20-92 to present).py.	USPA	2004/08/18 14:06			0
7	BRS	L7	0	4 and @pd=19920520	USPA	2004/08/18 14:08			0
8	BRS	L8	128	4 and @py<1992	USPA	2004/08/18 14:08			0
9	BRS	L9	138	4 and @py<1993	USPA	2004/08/18 14:28			0
10	BRS	L11	0	10 and @py<1993	USPA	2004/08/18 14:17			0
11	BRS	L10	289	((circuit adj board) or substrate) same (heat adj sink) same spring$1	EPO; JPO; DERW ENT; IBM_ TDB	2004/08/18 14:23			0

Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
12 BRS	L12	612	((circuit adj board) or substrate) same (heat adj sink) same (pressed or compressed or resilient)	USPA T; EPO; JPO; DERW ENT; IBM_ TDB	2004/08/1 8 14:24			0
13 BRS	L13	452	12 not 6	USPA T; EPO; JPO; DERW ENT; IBM_ TDB	2004/08/1 8 14:24			0
14 BRS	L14	71	13 and @py<1993	USPA T	2004/08/1 8 14:24			0
15 BRS	L15	1152	((circuit adj board) or substrate) and (heat adj sink) same spring$1	USPA T	2004/08/1 8 14:51			0
16 BRS	L16	623	15 not 4	USPA T	2004/08/1 8 14:28			0
17 BRS	L17	180	16 and @py<1993	USPA T	2004/08/1 8 14:38			0
18 BRS	L18	362	((circuit adj board) or substrate) and (heat adj sink) same spring$1	EPO; JPO; DERW ENT; IBM_ TDB	2004/08/1 8 14:38			0
19 BRS	L19	0	18 and @py<1993	USPA T	2004/08/1 8 14:38			0

Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
20 BRS	L20	136	18 and @py<1993	USPA; T; EPO; JPO; DERW ; ENT; IBM_; TDB	2004/08/1 8 14:46			0
21 BRS	L21	175	((circuit adj board) or substrate)same processor same spring$1 spring$1	USPA; T; EPO; JPO; DERW ; ENT; IBM_; TDB	2004/08/1 8 14:46			0
22 BRS	L22	175	((circuit adj board) or substrate)same processor same spring$1	USPA; T; EPO; JPO; DERW ; ENT; IBM_; TDB	2004/08/1 8 14:49			0
23 BRS	L23	36	22 and @py<1993	USPA; T; EPO; JPO; DERW ; ENT; IBM_; TDB	2004/08/1 8 14:50			0
24 BRS	L24	51	((circuit adj board) or substrate)same processor same (resilient or compressible)	USPA; T; EPO; JPO; DERW ; ENT; IBM_; TDB	2004/08/1 8 14:49			0

Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
25 BRS	L25	9	24 and @py<1993	USPA T; EPO; JPO; DERW ENT; IBM_ TDB	2004/08/1 8 14:51			0
26 BRS	L26	3883	((circuit adj board) or substrate) and (heat adj sink) and spring$1	USPA T	2004/08/1 8 15:24			0
27 BRS	L27	1076	26 and @py<1993	USPA T; EPO; JPO; DERW ENT; IBM_ TDB	2004/08/1 8 15:16			0
28 BRS	L28	896	27 not 17	USPA T; EPO; JPO; DERW ENT; IBM_ TDB	2004/08/1 8 14:52			0
29 BRS	L29	896	28 not 20	USPA T; EPO; JPO; DERW ENT; IBM_ TDB	2004/08/1 8 14:53			0

Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
BRS	L30	427	((circuit adj board) or substrate) and (heat adj sink) and spring$1	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 15:16			0
BRS	L31	167	30 and @py<1993	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 15:22			0
BRS	L32	622	361/704.ccls. and spring$1	USPAT	2004/08/18 15:22			0
BRS	L33	56	32 and @py<1993	USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/08/18 15:25			0
BRS	L34	13437	((circuit adj board) or substrate) and cooling and spring$1	USPAT	2004/08/18 15:24			0
BRS	L35	1143223	34 not 26	USPAT	2004/08/18 15:24			0
BRS	L36	3137	35 and @py<1993	USPAT	2004/08/18 15:25			0
BRS	L37	259	36 and processor	USPAT	2004/08/18 15:26			0
BRS	L38	9	((circuit adj board) or substrate) same cooling same foam same housing	USPAT	2004/08/18 15:50			0

Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
BRS	L39	2	((circuit adj board) or substrate) same cooling same foam same housing	EPO; JPO; DERW ENT; IBM_ TDB	8 2004/08/1 15:46			0
BRS	L40	9	((circuit adj board) or substrate) same cooling same (compressible or compressed) same housing	EPO; JPO; DERW ENT; IBM_ TDB	8 2004/08/1 15:48			0
BRS	L41	6	((circuit adj board) or substrate) same cooling same (compressible or compressed) same housing	USPA T	8 2004/08/1 15:48			0
BRS	L42	0	((circuit adj board) or substrate) same cooling same (silicon same rubber) same housing	USPA T	8 2004/08/1 15:50			0
BRS	L43	0	((circuit adj board) or substrate) same cooling same (silicon same rubber) same housing	USPA T	8 2004/08/1 15:51			0
BRS	L44	24	((circuit adj board) or substrate) same cooling same (rubber) same housing	USPA T	8 2004/08/1 15:52			0
BRS	L45	12	((circuit adj board) or substrate) same cooling same between same compressible same compressor processor	USPA T	8 2004/08/1 15:54			0

Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
46	BRS	L46	1	((circuit adj board) or substrate) same compressible same processor	EPO; JPO; DERW ENT; IBM TDB	2004/08/1 8 15:55			0
47	BRS	L47	3	((circuit adj board) or substrate) between same resilient same processor	EPO; JPO; DERW ENT; IBM TDB	2004/08/1 8 15:55			0
48	BRS	L48	13	((circuit adj board) same between same resilient same processor	USPA T	2004/08/1 8 15:56			0
49	BRS	L49	62	((circuit adj board) or substrate) same between same spring same processor	USPA T	2004/08/1 8 15:58			0
50	BRS	L50	18	((circuit adj board) or substrate) same between same spring same processor	EPO; JPO; DERW ENT; IBM TDB	2004/08/1 8 16:00			0
51	BRS	L51	5	((circuit adj board) or substrate) same support same spring same processor	EPO; JPO; DERW ENT; IBM TDB	2004/08/1 8 16:01			0
52	BRS	L52	1	((circuit adj board) or substrate) same support same (rubber or foam) same processor	EPO; JPO; DERW ENT; IBM TDB	2004/08/1 8 16:02			0

Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Error Definition	Errors
53 BRS	L53	21	((circuit adj board) or substrate) same support same springs same processor	USPA T; EPO; JPO; DERW ENT; IBM_ TDB	2004/08/1 8 16:03			0